

Semico Fab Database Update Summary 2023

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Excel Workbook

Below are the column headings included in the Excel workbook accompanying this Word document. There are almost 1,150 rows in the workbook:

Status	MEMS
Company	Image Sensors
Previous Owner or Previous Company Name	Oth. Sensors
FabName	LED
Wafer Size (mm)	LED Drivers
Region	LCD Drivers
Country	Other
City	Bipolar
State/Region	Current Process Tech (nm)
Special Substrate	Capacity (wpm) 2018
University	Capacity (wpm) 2019
Development	Capacity (wpm) 2020
IDM	Capacity (wpm) 2021
Foundry	Capacity (wpm) 2022
Process Type	Capacity (wpm) 2023 (forecast)
Products	Construction Start
Logic	Initial Prod Yr
ASSPs	Vol Prod Yr
ASICs	Yr Closed or Closing
Analog	Employees
Discretes	Total Capex (millions)
Passives	Site Size
Opto	Total Fab Size (K sq. m)
DRAM	Cleanroom Size (K sq. m)
Mobile RAM	Updated Since Last Publish?
SRAM	
NAND - 2D	
NAND - 3D	
XPoint	
NOR	
Other NV Memory	